

04-11-2002

To the Honorable Commissioner of Patents



and original documents or copy thereof.
Address of receiving party(ies):

1. Name of conveying party(ies):

102052142

Chang-Oh JEONG, Bong-Joo KANG, and Jae-Gab LEE

Name: Samsung Electronics Co., Ltd.

Additional names of conveying party(ies) attached?

☐ yes ☒ no

Internal Address:

3. Nature of Conveyance

4-2-02

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Street Address: 416, Maetan-dong, Paldal-ku
City: Suwon-city, Kyunggi-do
State or Country: The Republic of KOREA

Additional name(s) & address(es) attached?
☐ yes ☒ no

Execution Date: March 29, 2002

4. Application number(s) or patent number(s):

Title: **WIRING LINE ASSEMBLY AND METHOD FOR MANUFACTURING THE SAME, AND
THIN FILM TRANSISTOR ARRAY SUBSTRATE HAVING THE WIRING LINE ASSEMBLY
AND METHOD FOR MANUFACTURING THE SAME**

If this document is being filed together with a new application, the execution date of the application is March 29, 2002

A. Patent Application No(s). filed on

10/112760

B. Patent No(s).

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Hae-Chan Park, Esq.
McGuireWoods LLP
1750 Tysons Boulevard, Suite 1800
McLean, Virginia 22102

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$ 40.00

☒ Enclosed

☒ Authorized to be charged to deposit account
☐ Total fee due
☒ Any deficiencies in the enclosed fees

8. Deposit account number: 23-1951

9. Statement and signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Hae-Chan Park
Name of Person Signing

Signature

April 2, 2002
Date

10/112760
04/02/02

ASSIGNMENT OF INVENTION

WHEREAS, I, Chang-Oh JEONG, Bong-Joo KANG, Jae-Gab LEE have invented certain new and useful improvements in WIRING LINE ASSEMBLY AND METHOD FOR MANUFACTURING THE SAME, AND THIN FILM TRANSISTOR ARRAY SUBSTRATE HAVING THE WIRING LINE ASSEMBLY AND METHOD FOR MANUFACTURING THE SAME for which a patent application has been executed.

AND WHEREAS, Samsung Electronics Co., Ltd. having a principal place of business at 416, Maetan-dong, Paldal-gu, Suwon-si, Gyeonggi-do, The Republic of KOREA, referred to as Assignee, is desirous of acquiring our interest in said invention and in any Letters Patent which may be granted therefor.

NOW THIS INDENTURE WITNESSETH, That for a valuable consideration, the receipt of which is hereby acknowledged, we hereby assign, sell and transfer unto the said assignee, the entire right, title and interest in and to inventions disclosed in said application and in and to any Letters Patent of the United States and in and to any Letters Patent or Inventor's Certificates of any and all foreign countries which may be granted therefor, and in and to any and all priority and/or Convention rights or benefits accruing or to accrue to me with respect to the filing or securing of patents in the United States and/or securing of patents or inventor's certificates in any and all countries foreign thereto.

AND I hereby grant to assignee the right to apply in its own name for patents or inventor's certificates corresponding to the above invention in countries foreign to the United States.

AND I hereby further agree to sign and properly execute such necessary and lawful papers for application for foreign patents and inventor's certificates for filing applications for United States, foreign patents and inventor's certificates for subdivisions of any applications for patent or inventor's certificate and/or for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention and to perform such further acts as may be required to carry out the intent of this agreement as the assignee thereof shall hereafter require and prepare at assignee's expense.

Dated: 2002-03-29

Chang - Oh JEONG
Name: Chang-Oh JEONG

Dated: 2002-03-29

Bong - Joo KANG
Name: Bong-Joo KANG

Dated: 2002-03-29

Jae - Gab Lee
Name: Jae-Gab LEE

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